

IN THE CLAIMS

The claims are as follows:

1. (Previously Presented) A holder for a cassette for semiconductor material substrates, comprising a base plate on which a guide member provided with at least two guides is secured, which cassette is arranged between the guides, which enable the cassette to be aligned and identically situated with respect to the base plate upon each introduction to the holder, and a first side of the guide member which is facing away from the base plate is embodied so as to taper inwards, wherein a second side of the guide member facing the base plate is also embodied so as to taper inwards, so that a portion of the guide member situated closest to the cassette is arranged at a predetermined distance from the base plate.
2. (Previously Presented) The holder as claimed in claim 1, wherein the second side facing the base plate is mirror symmetrical with respect to the first side facing away from the base plate.
3. (Previously Presented) The holder as claimed in claim 1, wherein, viewed in cross-section, the guides demonstrate a trapezoidal, inwardly directed profile.

4. (Previously Presented) The holder as claimed in claim 1, wherein the guide member and the base plate are provided with corresponding openings having the shape of an elongated slot the longitudinal directions of which are mutually substantially perpendicular and by means of which the guide member is detachably secured to the base plate by means of bolts and nuts.

5. (Previously Presented) The holder as claimed in claim 4, wherein the base plate is graduated at a location of two mutually perpendicular outer sides of the guide member.

6. (Previously Presented) The holder as claimed in claim 4, wherein the base plate, the bolts and the nuts are made of aluminum.

7. (Previously Presented) The holder as claimed in claim 1, wherein the guide member comprises two mirror-symmetrical guide members, which each form at least one guide, which adjoins a single side of the cassette.

8. (Previously Presented) The holder as claimed in claim 1, wherein the guide member is made from a material having a low coefficient of friction.

9. (Previously Presented) a device for the manufacture of semiconductor products in semiconductor substrates, provided with the holder as claimed in claim 1.

10. (Previously Presented) A device including the holder as claimed in claim 1, wherein the device is provided with detection means, which signal that the cassette for the substrates is present in the holder.